ASSOCIATION CONNECT	© Copyright 2005, IPC, I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Tyl Distribute													
Supplier Infor	rmation														
Company name*		(Company unique ID			Ţ	Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact Name		-	Title - Contact			I	Phone - Contact*					Email - Contact*			
Product-Env-Stev	wards]	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized Repre	esentative*	-	Title - Representative			I	Phone - Representative*				Email	Email - Representative*			
Product-Env-Stev	wards]	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Reque			em Number Mfr Item Name X573MTC 3V OCTAL D LATCH W				Effective Date	e Version Man		anufacturing	nufacturing Site		ht*	UOM	Unit Type
							2023-06-08		P.	PH4		73.596 mg		mg	Each
Ianufacturin	g Proccess Information	l ,													
Termina	rminal Plating / Grid Array Material		Terminal Base Alloy J.		J-STD-020 MS	L Rating	Peak Process Body Temperatur		e Max Time at Peak Temper		ature	Number	r of Reflow Cyc	cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		C		seco	onds	3		
Comments															
vel 1 - maximum	n time at peak temperature d	uring solde	ering is 10-3	0 seconds											
or more informa	ation regarding material com	position pl	lease refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimuly and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.25	mg	Supplier	Silicon (Si)	7440-21-3		1.25	mg
Die Attach	0.136	mg	Supplier	Silver (Ag)	7440-22-4		0.109	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.027	mg
Lead Frame	30.624	mg	Supplier	Magnesium (Mg)	7439-95-4		0.046	mg
			Supplier	Silicon (Si)	7440-21-3		0.199	mg
			В	Nickel (Ni)	7440-02-0		0.979	mg
			Supplier	Copper (Cu)	7440-50-8		29.4	mg
Mold Compound-Black	40.867	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		8.173	mg
			Supplier	Carbon Black (C)	1333-86-4		0.409	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		32.285	mg
Plating	0.223	mg	Supplier	Palladium (Pd)	7440-05-3		0.006	mg
			В	Nickel (Ni)	7440-02-0		0.213	mg
			Supplier	Gold (Au)	7440-57-5		0.004	mg
Wire Bond - Au	0.496	mg	Supplier	Gold (Au)	7440-57-5		0.496	mg